

MODEL:

TANK-101B/BW

IEI Technology Corp.

Fanless Embedded System with Intel® Atom™ D525/N455 CPU, On-board 1.0 GB DDR3 Memory, Two Isolated CAN-Bus Ports, One Isolated Serial Port, RoHS Compliant

User Manual



in Mink, Cry

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Revision

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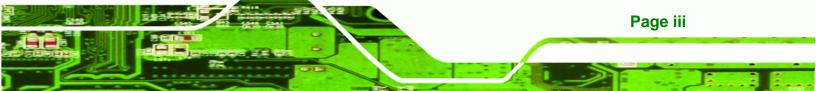




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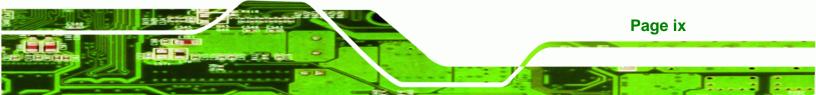
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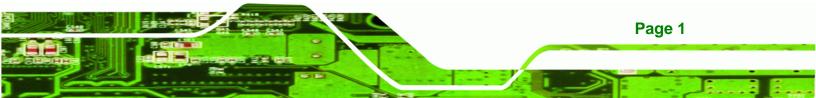
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Introduction





1.1 Overview



Figure 1-1: TANK-101B/BW

The TANK-101B/BW fanless embedded system is powered by the Intel® AtomTM D525/N455 processor, uses the Intel® ICH8M chipset and has 1.0 GB of DDR3 memory. With typical voltage at 12V DC, TANK-101B/BW can take wide range DC input from 9V to 36V as power source. It also has COM and CAN-Bus ports with isolation protection, dual Gigabit LAN and 802.11b/g/n wireless module for high speed communication. TANK-101B/BW supports all these versatile functions in a compact enclosure yet support fanless operation.

1.2 Model Variations

The model variations of the TANK-101B/BW are listed below.

Model No.	CPU	Wireless
TANK-101B-R10/D525/1GB	Intel® Atom™ D525 1.8 GHz dual core	No
TANK-101B-R10/N455/1GB	Intel® Atom™ N455 1.66 GHz	No
TANK-101BW-R10/D525/1GB	Intel® Atom™ D525 1.8 GHz dual core	Yes

Table 1-1: TANK-101B/BW Model Variations

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1.3 Features

The TANK-101B/BW features are listed below:

- Intel® AtomTM D525 1.8 GHz/N455 1.66 GHz processor
- 1.0 GB of DDR3 memory preinstalled
- Wide range 9V~36V DC power input
- Built-in 802.11b/g/n wireless module (for wireless model only)

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- Two CAN-Bus ports with isolation protection
- Two Gigabit Ethernet ports
- Four USB 2.0 ports
- Three RS-232 serial ports
- One RS-422/485 serial ports with isolation
- One VGA port
- One Line-out and one Mic-in audio jacks
- One CompactFlash® socket
- RoHS compliant

1.4 Technical Specifications

The TANK-101B/BW technical specifications are listed in Table 1-2.

Specifications		
СРИ	1.8 GHz Intel® Atom TM D525 CPU with 1 MB L2 cache or	
	1.66 GHz Intel® Atom [™] N455 CPU with 512 KB L2 cache	
System Chipset	Intel® ICH8M	
System Memory	1.0 GB of DDR3 memory preinstalled	
	One 204-pin DDR3 SDRAM SO-DIMM slot (system max. 2.0 GB)	
Ethernet	Dual Realtek RTL8111E PCIe GbE controllers (LAN1 with ASF 2.0	
	support)	
	Built-in 802.11b/g/n wireless module for the wireless model	
Serial Port	3 x RS-232 serial port (COM4: With isolation)	
	1 x RS-422/485 serial port with isolation (Default: RS-422)	
USB	4 x USB 2.0 ports	



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TANK-101B/BW Embedded System

Specifications		
Display	1 x VGA port	
Resolution	Up to 2048x1536 @ 60 Hz (D525 model)	
	Up to 1400x1050 @ 60 Hz (N455 model)	
Audio	1 x Line-out port	
	1 x Mic-in port	
CAN-Bus	2 x CAN-Bus ports with isolation	
Expansions	One PCIe Mini card slot (reserved for wireless module)	
Storage	One 2.5" SATA HDD supported	
	One CompactFlash® socket	
Power Supply	9V~36V DC input	
Power Consumption 12 W @ 1.85A (Intel® Atom TM D525 1.8 GHz with 1 MB L2		
1.0 GB DDR3 memory)		
Mounting Wall mount		
Operating Temperature	-20°C~60°C (D525 model with CompactFlash®/SSD*)	
	-20°C~70°C (N455 model with CompactFlash®/SSD*)	
	-10°C~50°C (with Wi-Fi)	
	*Ambient air speed per IEC-68-2-2 standard	
Operating Shock	Half-sine wave shock 3G; 11ms; 3 shocks per axis	
Operating Vibration	MIL-STD-810F 514.5C-1 (HDD)	
	MIL-STD-810F 514.5C-2 (CF)	
Color	Cool Gray + Blue	
Chassis Construction	Aluminum alloy with heavy duty metal	
Weight (Net/Gross)	: (Net/Gross) 2.1 kg/3.9 kg	
Physical Dimensions	Dimensions 248 mm x 153 mm x 44 mm (W x D x H)	

Table 1-2: Technical Specifications

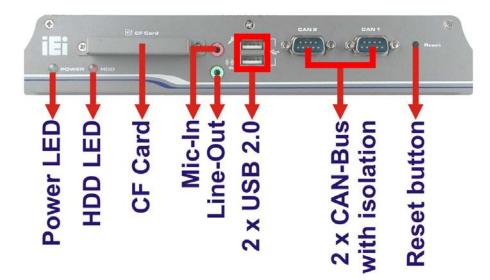
1.5 Connector Panel

1.5.1 Front Panel

The TANK-101B/BW front panel contains:

- 2 x CAN-Bus ports with isolation
- 1 x CompactFlash® card socket
- 1 x HDD LED indicator
- 1 x Line-out port (green)
- 1 x Mic-in port (pink)
- 1 x Power LED indicator
- 1 x Reset button
- 2 x USB 2.0 port connectors

An overview of the front panel is shown in **Figure 1-2** below.



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Figure 1-2: TANK-101B/BW Front Panel



1.5.2 Rear Panel

The TANK-101B/BW rear panel contains:

- 1 x VGA output
- 3 x RS-232 serial ports (COM4: With isolation)
- 1 x RS-422/485 serial port with isolation (Default: RS-422)
- 2 x USB port connectors
- 2 x Gigabit Ethernet ports (LAN1 with ASF 2.0 support)
- 1 x 12V DC power jack
- 1 x 3-pin power terminal block with wide range power input (9V~36V)
- 1 x Power switch
- 2 x Wireless antenna connectors (for wireless model only)

An overview of the rear panel is shown in Figure 1-3 below.

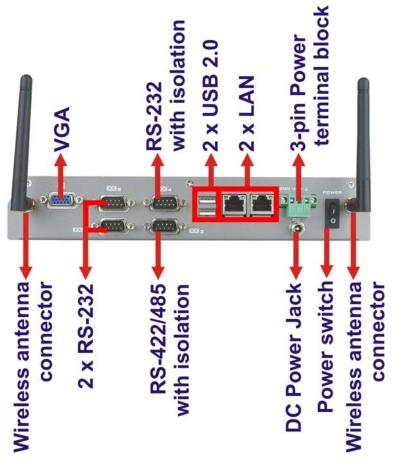
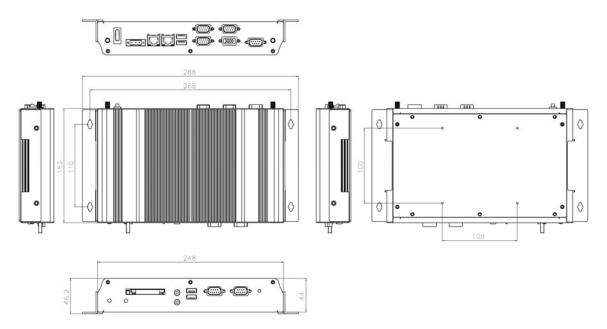


Figure 1-3: TANK-101B/BW Rear Panel

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1.6 Dimensions

The physical dimensions are shown below:

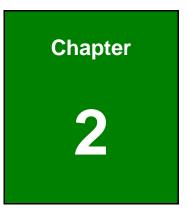


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Figure 1-4: Physical Dimensions (millimeters)







Unpacking







Failure to take ESD precautions during installation may result in permanent damage to the TANK-101B/BW and severe injury to the user.

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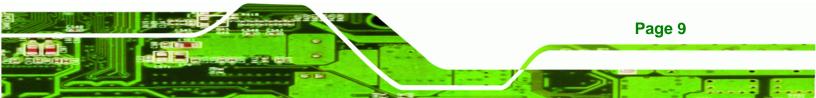
Electrostatic discharge (ESD) can cause serious damage to electronic components, including the TANK-101B/BW. Dry climates are especially susceptible to ESD. It is therefore critical that whenever the TANK-101B/BW or any other electrical component is handled, the following anti-static precautions are strictly adhered to.

- Wear an anti-static wristband: Wearing a simple anti-static wristband can help to prevent ESD from damaging the board.
- Self-grounding: Before handling the board touch any grounded conducting material. During the time the board is handled, frequently touch any conducting materials that are connected to the ground.
- Use an anti-static pad: When configuring the TANK-101B/BW, place it on an antic-static pad. This reduces the possibility of ESD damaging the TANK-101B/BW.

2.2 Unpacking Precautions

When the TANK-101B/BW is unpacked, please do the following:

- Follow the anti-static precautions outlined in **Section 2.1**.
- Make sure the packing box is facing upwards so the TANK-101B/BW does not fall out of the box.
- Make sure all the components shown in Section 2.3 are present.





2.3 Unpacking Checklist

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If some of the components listed in the checklist below are missing, please do not proceed with the installation. Contact the IEI reseller or vendor you purchased the TANK-101B/BW from or contact an IEI sales representative directly. To contact an IEI sales representative, please send an email to <u>sales@iei.com.tw</u>.

The TANK-101B/BW is shipped with the following components:

Quantity	Item and Part Number	Image		
Standard				
1	TANK-101B/BW Series			
1	Power adapter (P/N : 63000-FSP060DBAB1552-RS)			
1	Power cord			
1	SATA and power cable			
2	Mounting bracket			

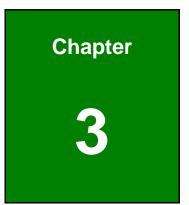
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Quantity	Item and Part Number	Image		
Standard				
1	Screw set			
1	Quick Installation Guide	EXTERNATION OF PETOMOLOGY CONTRACTOR CON		
1	User manual and driver CD (P/N : 7B000-000087-RS)			
2	Wireless antenna (wireless model only)			
1	VESA MIS-D 100 wall mount kit (optional)			

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Installation



3.1 Installation Precautions

During installation, be aware of the precautions below:

 Read the user manual: The user manual provides a complete description of the TANK-101B/BW, installation instructions and configuration options.

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- DANGER! Disconnect Power: Power to the TANK-101B/BW must be disconnected during the installation process, or before any attempt is made to access the rear panel. Electric shock and personal injury might occur if the rear panel of the TANK-101B/BW is opened while the power cord is still connected to an electrical outlet.
- Qualified Personnel: The TANK-101B/BW must be installed and operated only by trained and qualified personnel. Maintenance, upgrades, or repairs may only be carried out by qualified personnel who are familiar with the associated dangers.
- Air Circulation: Make sure there is sufficient air circulation when installing the TANK-101B/BW. The TANK-101B/BW's cooling vents must not be obstructed by any objects. Blocking the vents can cause overheating of the TANK-101B/BW. Leave at least 5 cm of clearance around the TANK-101B/BW to prevent overheating.
- Grounding: The TANK-101B/BW should be properly grounded. The voltage feeds must not be overloaded. Adjust the cabling and provide external overcharge protection per the electrical values indicated on the label attached to the back of the TANK-101B/BW.

3.2 CF Card Installation

To install the CF card, please follow the steps below:

Step 1: Locate the CF card slot on the front panel of the TANK-101B/BW.





- Step 2: Remove the CF card slot cover by removing the two retention screws (Figure
 - **3-1**).





Step 3: Insert the CF card into the slot (Figure 3-2).



Figure 3-2: CF Card Installation

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3.3 Hard Disk Drive (HDD) Installation

To install the hard drive, please follow the steps below:

Step 1: Remove the bottom panel by removing the 10 retention screws from the bottom panel (**Figure 3-3**).

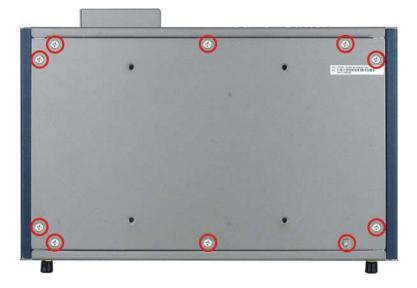


Figure 3-3: Bottom Panel Retention Screws

Step 2: Open the bottom panel, unplug the SATA signal and power cables connected to the TANK-101B/BW, and then put the bottom panel on a flat surface.

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Step 3: Attach the HDD to the HDD bracket, and then slide the HDD to connect the HDD to the SATA connector (**Figure 3-4**).

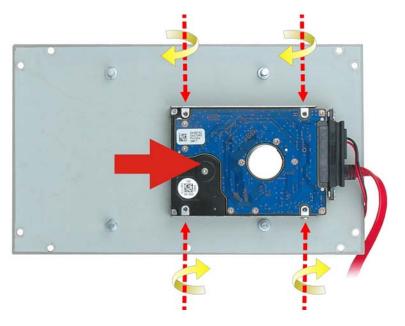
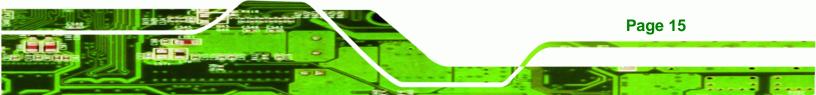


Figure 3-4: HDD Installation

Step 4: Secure the HDD with the HDD bracket by four retention screws (**Figure 3-4**).





Step 5: Reconnect the SATA signal and power cables to the TANK-101B/BW.

Step 6: Reinstall the bottom panel.

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3.4 Mounting the System with Mounting Brackets

To mount the embedded system onto a wall or some other surface using the two mounting brackets, please follow the steps below.

- Step 1: Turn the embedded system over.
- **Step 2:** Align the two retention screw holes in each bracket with the corresponding retention screw holes on the sides of the bottom surface.



Figure 3-5: Retention Screw Holes

- Step 3: Secure the brackets to the system by inserting two retention screws into each bracket.
- **Step 4:** Drill holes in the intended installation surface.
- **Step 5:** Align the mounting holes in the sides of the mounting brackets with the predrilled holes in the mounting surface.
- Step 6: Insert four retention screws, two in each bracket, to secure the system to the wall.



3.5 Mounting the System with Wall Mount Kit

To mount the embedded system onto a wall using the VESA MIS-D 100 wall mount kit, please follow the steps below.

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- Step 1: Select the location on the wall for the wall-mounting bracket.
- Step 2: Carefully mark the locations of the four bracket screw holes on the wall.
- **Step 3:** Drill four pilot holes at the marked locations on the wall for the bracket retention screws.
- **Step 4:** Align the wall-mounting bracket screw holes with the pilot holes.
- Step 5: Secure the mounting-bracket to the wall by inserting the retention screws into the four pilot holes and tightening them (Figure 3-6).

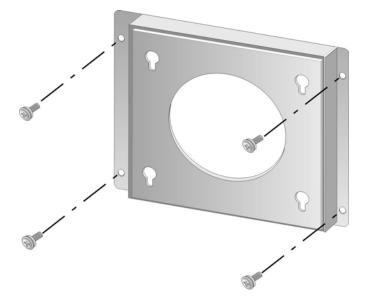
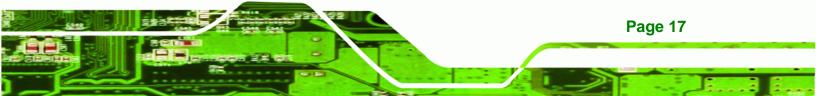


Figure 3-6: Wall-mounting Bracket

- Step 6: Insert the four monitor mounting screws provided in the wall mounting kit into the four screw holes on the bottom panel of the system and tighten until the screw shank is secured against the bottom panel (Figure 3-7).
- Step 7: Align the mounting screws on the TANK-101B/BW bottom panel with the mounting holes on the bracket.



Step 8: Carefully insert the screws through the holes and gently pull the monitor downwards until the TANK-101B/BW rests securely in the slotted holes (Figure 3-7). Ensure that all four of the mounting screws fit snuggly into their respective slotted holes.



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In the diagram below the bracket is already installed on the wall.

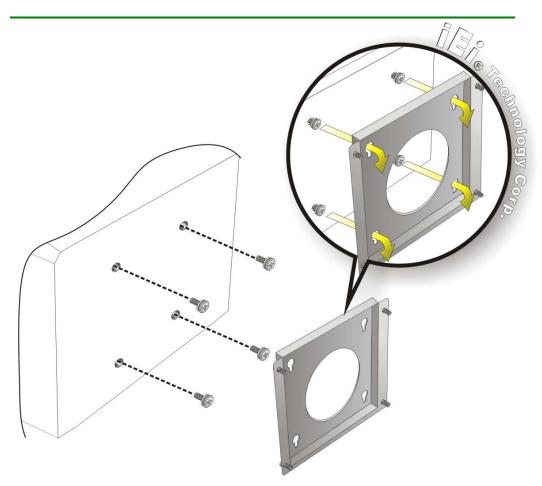


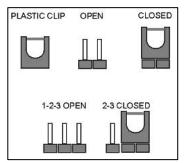
Figure 3-7: Mount the Embedded System



3.6 Jumper Settings



A jumper is a metal bridge used to close an electrical circuit. It consists of two or three metal pins and a small metal clip (often protected by a plastic cover) that slides over the pins to connect them. To CLOSE/SHORT a jumper means connecting the pins of the jumper with



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the plastic clip and to OPEN a jumper means removing the plastic clip from a jumper.

To access jumpers, please remove the bottom panel (refer to **Section 3.3**). The motherboard jumpers are listed below.

- Clear CMOS jumper
- RS-422/485 (COM3) function select jumper

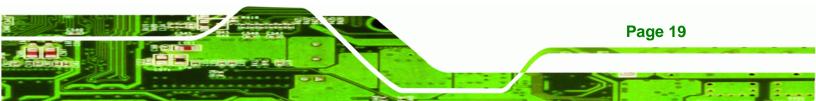
3.6.1 Clear CMOS Jumper

Jumper Label:	J_CMOS1	
Jumper Type:	3-pin header	
Jumper Settings:	See Table 3-1	

To reset the BIOS, move the jumper to the "Clear CMOS" position for 3 seconds or more, and then move back to the default position.

Setting	Description
Short 1-2	Normal
Short 2-3	Clear CMOS

Table 3-1: Clear CMOS Jumper Settings





3.6.2 RS-422/485 (COM3) Function Select Jumper

Jumper Label:	J12
Jumper Type:	Pin headers
Jumper Settings:	See Table 3-2

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The RS-422/485 Function Select jumper sets the communication protocol used by the third serial communications port (COM3) as RS-422 or RS-485. The COM3 Function Select settings are shown below.

Setting	Description	
Short 1-3	RS-422 TX- (Default)	
Short 3-5	RS-485 D-	
Short 2-4	RS-422 TX+ (Default)	
Short 4-6	RS-485 D+	

Table 3-2: RS-422/485 (COM3) Setup

3.7 External Peripheral Interface Connectors

The TANK-101B/BW has the following connectors. Detailed descriptions of the connectors can be found in the subsections below.

- Audio
- CAN-Bus
- CompactFlash® card
- Ethernet
- Power switch
- Power input
- Reset button
- RS-232
- RS-422/485
- USB
- VGA
- Wireless antenna (for wireless model only)

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3.7.1 Audio Connector

CN Type:	Audio jack
CN Location:	See Figure 3-8

The audio jacks connect to external audio devices.

 Line Out port (Green): Connects to a headphone or a speaker. With multi-channel configurations, this port can also connect to front speakers.

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• Microphone (Pink): Connects a microphone.



Figure 3-8: Audio Connector

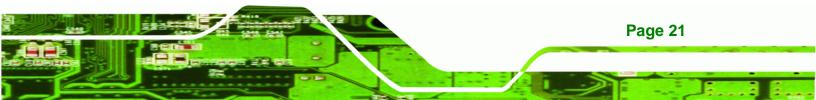
3.7.2 CAN-Bus Connectors

CN Type:	DB-9 connector
CN Location:	See Figure 1-2
CN Pinouts:	See Table 3-3 and Figure 3-9

There are two CAN-Bus connectors with isolation. The pinouts for the CAN-Bus connector are listed in the table below.

Pin	Description	Pin	Description
1	NC	6	NC
2	CANL	7	CANH
3	GND	8	NC
4	NC	9	NC
5	NC		

Table 3-3: CAN-Bus Connector Pinouts



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TANK-101B/BW Embedded System

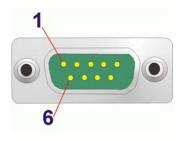


Figure 3-9: CAN-Bus Connector Pinout Location

3.7.3 CompactFlash® Card Slot

The TANK-101B/BW has one CF card slot. To install the CF card, refer to **Section 3.2**.

3.7.4 LAN Connectors

CN Type:	RJ-45
CN Location:	See Figure 1-3
CN Pinouts:	See Table 3-4

The LAN connectors allow connection to an external network.

- Step 1: Locate the RJ-45 connectors. The locations of the RJ-45 connectors are shown in Figure 1-3.
- Step 2: Align the connectors. Align the RJ-45 connector on the LAN cable with one of the RJ-45 connectors on the TANK-101B/BW. See Figure 3-10.





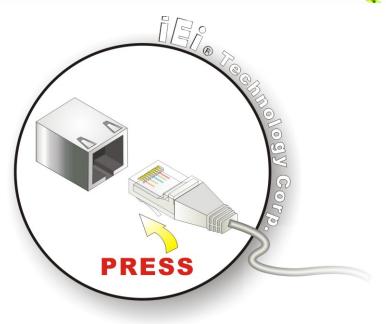


Figure 3-10: LAN Connection

Step 3: Insert the LAN cable RJ-45 connector. Once aligned, gently insert the LAN

cable RJ-45 connector into the on-board RJ-45 connector.

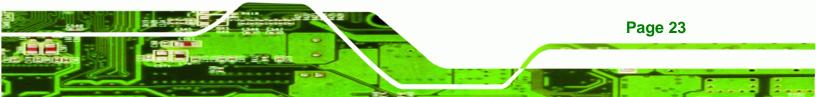
Pin	Description	Pin	Description
1	TRD1P0	5	TRD1P2
2	TRD1N0	6	TRD1N2
3.	TRD1P1	7	TRD1P3
4.	TRD1N1	8	TRD1N3

Table 3-4: LAN Pinouts



Figure 3-11: RJ-45 Ethernet Connector

The RJ-45 Ethernet connector has two status LEDs, one green and one yellow. The green LED indicates activity on the port and the yellow LED indicates the port is linked. See **Table 3-5**.





Activity/Lin	ctivity/Link LED Speed LED		
STATUS	DESCRIPTION	STATUS	DESCRIPTION
Off	No link	Off	10 Mbps connection
Yellow	Linked	Green	100 Mbps connection
Blinking	TX/RX activity	Orange	1 Gbps connection

Table 3-5: RJ-45 Ethernet Connector LEDs

3.7.5 3-pin Power Terminal Block

CN Type:	3-pin terminal block	
CN Location:	See Figure 1-3	
N Pinouts:	See Figure 3-12	

Connect the leads of a 9V~36V DC power supply into the terminal block. Make sure that the power and ground wires are attached to the correct sockets of the connector.

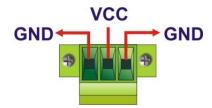


Figure 3-12: 3-pin Terminal Block Pinout Location

3.7.6 RS-232 or RS-422/485 Serial Port Connectors

- CN Label: COM1, COM2, COM3 and COM4
- **CN Type:** DB-9 connectors
- CN Location: See Figure 1-3
- CN Pinouts: See Table 3-6 and Figure 3-14

RS-232 or RS-422/485 serial port devices can be attached to the DB-9 ports on the rear panel.

Step 1: Locate the DB-9 connector. The locations of the DB-9 connectors are shown

in Figure 1-3.



Step 2: Insert the serial connector. Insert the DB-9 connector of a serial device into

the DB-9 connector on the external peripheral interface. See Figure 3-13.

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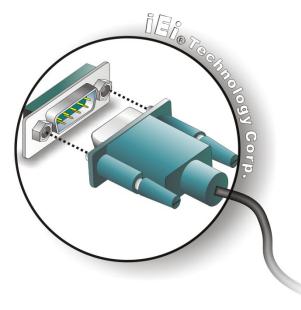


Figure 3-13: Serial Device Connector

Step 3: Secure the connector. Secure the serial device connector to the external

interface by tightening the two retention screws on either side of the connector.

Pin	Description	Pin	Description
1	DCD	6	DSR
2	RX	7	RTS
3	ТХ	8	CTS
4	DTR	9	RI
5	GND		

Table 3-6: Serial Port Pinouts

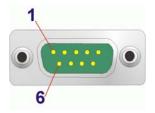
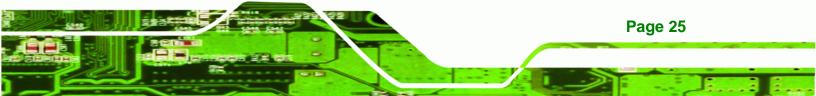


Figure 3-14: Serial Port Pinout Location



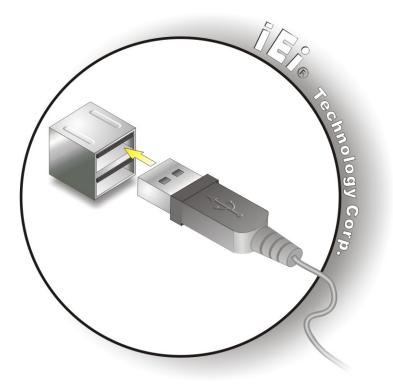


3.7.7 USB Connectors

CN Type:	USB port
CN Location:	See Figure 1-2 and Figure 1-3
CN Pinouts:	See Table 3-7

The USB ports are for connecting USB peripheral devices to the system.

- Step 1: Locate the USB connectors. The locations of the USB connectors are shown in Figure 1-2 and Figure 1-3.
- Step 2: Align the connectors. Align the USB device connector with one of the connectors. See Figure 3-15.





Step 3: Insert the device connector. Once aligned, gently insert the USB device connector into the on-board connector.



Pin	Description	Pin	Description
1	VCC	5	VCC
2	DATA-	6	DATA-
3	DATA+	7	DATA+
4	GROUND	8	GROUND

Table 3-7: USB Port Pinouts

3.7.8 VGA Connector

CN Label:	VGA
CN Type:	15-pin Female
CN Location:	See Figure 1-2
CN Pinouts:	See Figure 3-17 and Table 3-8

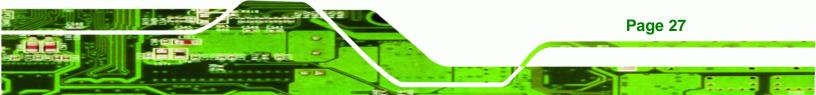
The VGA connector connects to a monitor that accepts VGA video input.

- Step 1: Locate the female DB-15 connector. The location of the female DB-15 connector is shown in Figure 1-2.
- **Step 2:** Align the VGA connector. Align the male DB-15 connector on the VGA screen cable with the female DB-15 connector on the external peripheral interface.

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Step 3: Insert the VGA connector Once the connectors are properly aligned with the insert the male connector from the VGA screen into the female connector on the TANK-101B/BW. See Figure 3-16.





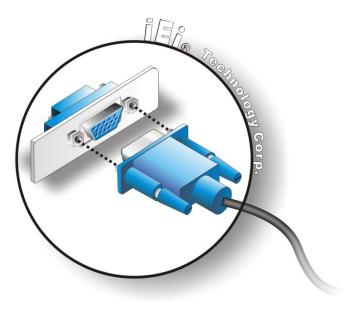


Figure 3-16: VGA Connector

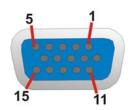


Figure 3-17: VGA Connector

Pin	Description	Pin	Description
1	RED	2	GREEN
3	BLUE	4	NC
5	GND	6	GND
7	GND	8	GND
9	VCC / NC	10	GND
11	NC	12	DDC DAT
13	HSYNC	14	VSYNC
15	DDCCLK	\searrow	

Table 3-8: VGA Connector Pinouts



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BIOS





4.1 Introduction

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The BIOS is programmed onto the BIOS chip. The BIOS setup program allows changes to certain system settings. This chapter outlines the options that can be changed.

4.1.1 Starting Setup

The UEFI BIOS is activated when the computer is turned on. The setup program can be activated in one of two ways.

- 1. Press the DEL or F2 key as soon as the system is turned on or
- 2. Press the **DEL** or **F2** key when the "**Press DEL or F2 to enter SETUP**" message appears on the screen.

If the message disappears before the **DEL or F2** key is pressed, restart the computer and try again.

4.1.2 Using Setup

Use the arrow keys to highlight items, press **ENTER** to select, use the PageUp and PageDown keys to change entries, press **F1** for help and press **Esc** to quit. Navigation keys are shown in.

Кеу	Function
Up arrow	Move to previous item
Down arrow	Move to next item
Left arrow	Move to the item on the left hand side
Right arrow	Move to the item on the right hand side
+	Increase the numeric value or make changes
-	Decrease the numeric value or make changes
Page Up key	Increase the numeric value or make changes
Page Dn key	Decrease the numeric value or make changes

Кеу	Function
Esc key	Main Menu – Quit and not save changes into CMOS
	Status Page Setup Menu and Option Page Setup Menu
	Exit current page and return to Main Menu
F1	General help, only for Status Page Setup Menu and Option
	Page Setup Menu
F2	Previous values
F3	Load optimized defaults
F4	Save changes and Exit BIOS

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Table 4-1: BIOS Navigation Keys

4.1.3 Getting Help

When **F1** is pressed a small help window describing the appropriate keys to use and the possible selections for the highlighted item appears. To exit the Help Window press **Esc** or the **F1** key again.

4.1.4 Unable to Reboot After Configuration Changes

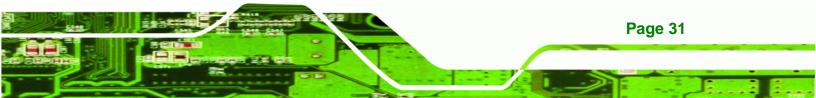
If the computer cannot boot after changes to the system configuration is made, CMOS defaults. Use the jumper described in Chapter 2.

4.1.5 BIOS Menu Bar

The menu bar on top of the BIOS screen has the following main items:

- Main Changes the basic system configuration.
- Advanced Changes the advanced system settings.
- Chipset Changes the chipset settings.
- Boot Changes the system boot configuration.
- Security Sets User and Supervisor Passwords.
- Save & Exit Selects exit options and loads default settings.

The following sections completely describe the configuration options found in the menu items at the top of the BIOS screen and listed above.





4.2 Main

The **Main** BIOS menu (**BIOS Menu 1**) appears when the **BIOS Setup** program is entered. The **Main** menu gives an overview of the basic system information.

	cility - Copyright (C) 2010 America Chipset Boot Security Save	-
BIOS Information BIOS Vendor Core Version Compliency Project Version Duild Date and Time	American Megatrends 4.6.4.0 0.20 UEFI 2.0 E329A11.ROM	Set the Date. Use Tab to switch between Data elements.
Build Date and Time System Date System Time	01/28/2011 11:53:40 [Mon 06/20/2011] [15:10:27]	←→: Select Screen ↑↓: Select Item
Access Level	Administrator	EnterSelect + - Change Opt. F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save & Exit ESC Exit
Version 2.02	.1205. Copyright (C) 2010 American	Megatrends, Inc.

BIOS Menu 1: Main

➔ System Overview

The **BIOS** Information lists a brief summary of the BIOS. The fields in **BIOS** Information cannot be changed. The items shown in the system overview include:

- BIOS Vendor: Installed BIOS vendor
- Core Version: Current BIOS version
- Project Version: the board version
- Build Date and Time: Date and time the current BIOS version was made

The System Overview field also has two user configurable fields:

➔ System Date [xx/xx/xx]

Use the **System Date** option to set the system date. Manually enter the day, month and year.



➔ System Time [xx:xx:xx]

Use the **System Time** option to set the system time. Manually enter the hours, minutes and seconds.

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4.3 Advanced

Use the **Advanced** menu (**BIOS Menu 2**) to configure the CPU and peripheral devices through the following sub-menus:



Setting the wrong values in the sections below may cause the system to malfunction. Make sure that the settings made are compatible with the hardware.

<pre>> ACPI Settings > Trusted Computing > CPU Configuration > IDE Configuration > USB Configuration > Super IO Configuration > H/M Monitor > Serial Port Console Redirection</pre>	Aptio Setup Utility - Copyright (C) 2010 America Main Advanced Chipset Boot Security Save	2
<pre>> IDE Configuration > USB Configuration > Super IO Configuration > H/M Monitor > Serial Port Console Redirection</pre>	> Trusted Computing	System ACPI Parameters
<pre>> Serial Port Console Redirection</pre>	<pre>> USB Configuration > Super IO Configuration</pre>	
F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save & Exit		↑↓: Select Item EnterSelect
F4 Save & Exit		F1 General Help F2 Previous Values
Version 2.02.1205. Copyright (C) 2010 American Megatrends, Inc.		F4 Save & Exit ESC Exit

BIOS Menu 2: Advanced





4.3.1 ACPI Settings

The **ACPI Settings** menu (**BIOS Menu 3**) configures the Advanced Configuration and Power Interface (ACPI) options.

Aptio Setup Utility Advanced	- Copyright (C) 2010 America	n Megatrends, Inc.
ACPI Sleep State	[S1 (CPU Stop Clock)]	Select the highest ACPI sleep state the system will enter when the SUSPEND button is pressed.
Version 2, 02, 1205	$Q_{\rm coveright}$ (Q) 2010 Amovigon	 ←→: Select Screen ↑↓: Select Item EnterSelect + - Change Opt. F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save & Exit ESC Exit
Version 2.02.1205.	Copyright (C) 2010 American	Megatrends, Inc.

BIOS Menu 3: ACPI Configuration

→ ACPI Sleep State [S1 (CPU Stop Clock)]

Use the **ACPI Sleep State** option to specify the sleep state the system enters when it is not being used.

Suspend Disabled

S1 (CPU Stop DEFAULT The system enters S1(POS) sleep state. The system appears off. The CPU is stopped; RAM is refreshed; the system is running in a low power

mode.

 S3 (Suspend to RAM)
 The caches are flushed and the CPU is powered off. Power to the RAM is maintained. The computer returns slower to a working state, but

more power is saved.

4.3.2 Trusted Computing

Use the **Trusted Computing** menu (**BIOS Menu 4**) to configure settings related to the Trusted Computing Group (TCG) Trusted Platform Module (TPM).

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Aptio Setup Utility - Cop Advanced	yright (C)	2010 Americar	n Megatrends, Inc.
TPM Configuration TPM SUPPORT Current TPM Status Information	[Disable]		Enables or Disables TPM support. O.S. will not show TPM. Reset of platform is required.
TPM Hardware OFF			practorm is required.
			\leftrightarrow : Select Screen
			$\uparrow\downarrow$: Select Item
			EnterSelect
			+ - Change Opt.
			F1 General Help
			F2 Previous Values
			F3 Optimized Defaults
			F4 Save & Exit
			ESC Exit
Version 2.02.1205. Copy:	right (C) 2	010 American	Megatrends, Inc.

BIOS Menu 4: TPM Configuration

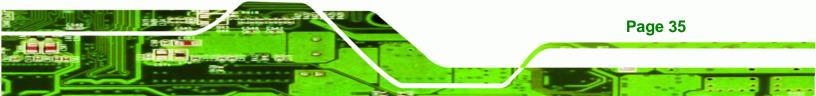
→ TPM Support [Disable]

Use the **TPM Support** option to configure support for the TPM.

- Disable DEFAULT TPM support is disabled.
- ➔ Enable TPM support is enabled.

4.3.3 CPU Configuration

Use the **CPU Configuration** menu (**BIOS Menu 5**) to view detailed CPU specifications and configure the CPU.



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Aptio Setup Utility Advanced	y - Copyright (C) 2010 America	n Megatrends, Inc.
CPU Configuration		
Processor Type	Intel(R) Atom(TM) CPU D525 @ 1.80GHz	
EMT64	Supported	
Processor Speed	1800 MHz	
System Bus Speed	800 MHz	\leftrightarrow : Select Screen
Ratio Status	9	$\uparrow \downarrow$: Select Item
Actual Ratio	9	EnterSelect
Processor Stepping	106ca	+ - Change Opt.
Microcode Revision	263	F1 General Help
L1 Cache RAM	2x56 k	F2 Previous Values
L2 Cache RAM	2x512 k	F3 Optimized Defaults
Processor Core	Dual	F4 Save & Exit
Hyper-Threading	Supported	ESC Exit
Version 2.02.1205	. Copyright (C) 2010 American	Megatrends, Inc.

BIOS Menu 5: CPU Configuration

The CPU Configuration menu (**BIOS Menu 5**) lists the following CPU details:

- Processor Type: Lists the brand name of the CPU being used
- EMT64: Indicates if the EM64T is supported by the CPU.
- Processor Speed: Lists the CPU processing speed
- System Bus Speed: Lists the system bus
- Ratio Status: List the maximum FSB divisor
- Actual Ratio: Lists current FSB divisor
- Processor Stepping: Lists the CPU processing stepping
- Microcode Revision: Lists the microcode revision
- L1 Cache RAM: Lists the CPU L1 cache size
- L2 Cache RAM: Lists the CPU L2 cache size
- Processor Core: Lists the number of the processor core
- Hyper-Threading: Indicates if the Intel Hyper-Threading Technology is supported by the CPU.

4.3.4 IDE Configuration

Use the **IDE Configuration** menu (**BIOS Menu 6**) to change and/or set the configuration of the SATA devices installed in the system.



Aptio Setup Utility Advanced	- Copyright (C) 2010 Americ	an Megatrends, Inc.
PATA Master PATA Slave	Not Present Not Present	Select ATA or IDE Configuration.
SATA Port0 SATA Port1 SATA Port2	Not Present Not Present Not Present	
SATA Port3 ATA or IDE Configuration Configure SATA as	Not Present [Enhanced] [IDE]	<pre>←→: Select Screen ↑↓: Select Item EnterSelect + - Change Opt.</pre>
		 F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save & Exit
Version 2.02.1205.	Copyright (C) 2010 America	ESC Exit

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BIOS Menu 6: IDE Configuration

→ ATA or IDE Configuration [Enhanced]

Use the ATA or IDE Configuration option to configure the ATA/IDE controller.

- Disabled Disables the on-board ATA/IDE controller.
 Compatible Configures the on-board ATA/IDE controller to be in compatible mode. In this mode, a SATA channel will replace one of the IDE channels. This mode supports up to 4 storage devices.
- Enhanced DEFAULT Configures the on-board ATA/IDE controller to be in Enhanced mode. In this mode, IDE channels and SATA channels are separated. This mode supports up to 6 storage devices. Some legacy OS do not support this mode.

→ Configure SATA as [IDE]

Use the **Configure SATA as** option to configure SATA devices as normal IDE devices.

- **IDE DEFAULT** Configures SATA devices as normal IDE device.
- AHCI Configures SATA devices as AHCI device.





4.3.5 USB Configuration

Use the **USB Configuration** menu (**BIOS Menu 7**) to read USB configuration information and configure the USB settings.

1 Keyboard if no USB devices are connected. DISABLE	Aptio Setup Utility Advanced	- Copyright (C) 2010 America	an Megatrends, Inc.
USB Devices: 1 Keyboard 1 Ke	USB Configuration		5 1
	002 2012000		disables legacy support if no USB devices are
	Legacy USB Support	[Enabled]	option will keep USB devices available only
←→: Select Screen			←→· Select Screen
↑↓: Select Item			$\uparrow \downarrow$: Select Item
EnterSelect + - Change Opt.			+ - Change Opt.
F1 General Help F2 Previous Values			_
F3 Optimized Default F4 Save & Exit			F3 Optimized Defaults
Version 2.02.1205. Copyright (C) 2010 American Megatrends, Inc.	ttension 2,02,1205	Comminist (C) 2010 Amonicou	ESC Exit

BIOS Menu 7: USB Configuration

➔ USB Devices

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The USB Devices field lists the USB devices that are enabled on the system

→ Legacy USB Support [Enabled]

Use the **Legacy USB Support** BIOS option to enable USB mouse and USB keyboard support. Normally if this option is not enabled, any attached USB mouse or USB keyboard does not become available until a USB compatible operating system is fully booted with all USB drivers loaded. When this option is enabled, any attached USB mouse or USB keyboard can control the system even when there is no USB driver loaded onto the system.

Enabled DEFAULT Legacy USB support enabled

- Disabled
 Legacy USB support disabled
- Auto
 Legacy USB support disabled if no USB devices are
 connected

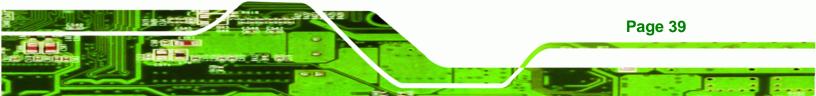
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4.3.6 Super IO Configuration

Use the **Super IO Configuration** menu (**BIOS Menu 8**) to set or change the configurations for the serial ports.

Aptio Setup Utility - Copyright (C) 2010 America Advanced	n Megatrends, Inc.
Super IO Configuration	Set Parameters of Serial Port 1 (COMA)
Super IO Chip Finteck F81865	
<pre>> Serial Port 1 Configuration > Serial Port 2 Configuration > Serial Port 3 Configuration > Serial Port 4 Configuration</pre>	<pre></pre>
Version 2.02.1205. Copyright (C) 2010 American	ESC Exit Megatrends, Inc.

BIOS Menu 8: Super IO Configuration





4.3.6.1 Serial Port n Configuration

Use the Serial Port n Configuration menu (BIOS Menu 9) to configure the serial port n.

Aptio Setup Utility - Copy Advanced	right (C) 2010 America	n Megatrends, Inc.
Serial Port n Configuration Serial Port Device Settings	[Enabled] IO=3F8h; IRO=4	Enable or Disable Serial Port (COM)
Change Settings	[Auto]	<pre></pre>
		EnterSelect Item + - Change Opt.
		F1 General HelpF2 Previous ValuesF3 Optimized Defaults
		F4 Save & Exit ESC Exit
Version 2.02.1205. Copyr:	ight (C) 2010 American	Megatrends, Inc.

BIOS Menu 9: Serial Port n Configuration Menu

4.3.6.1.1 Serial Port 1 Configuration

→ Serial Port [Enabled]

Use the Serial Port option to enable or disable the serial port.

→	Disabled	Disable the serial port
---	----------	-------------------------

Enabled DEFAULT Enable the serial port

→ Change Settings [Auto]

Use the **Change Settings** option to change the serial port IO port address and interrupt address.

→	Auto	DEFAULT	The serial port IO port address and interrupt address
			are automatically detected.
→	IO=3F8h;		Serial Port I/O port address is 3F8h and the interrupt
	IRQ=4		address is IRQ4

→	IO=3F8h; IRQ=3, 4	Serial Port I/O port address is 3F8h and the interrupt address is IRQ3, 4
→	IO=2F8h; IRQ=3, 4	Serial Port I/O port address is 2F8h and the interrupt address is IRQ3, 4
→	IO=2C0h; IRQ=3, 4	Serial Port I/O port address is 2C0h and the interrupt address is IRQ3, 4
→	IO=2C8h; IRQ=3, 4	Serial Port I/O port address is 2C8h and the interrupt address is IRQ3, 4

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4.3.6.1.2 Serial Port 2 Configuration

→ Serial Port [Enabled]

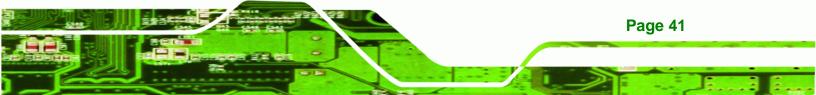
Use the Serial Port option to enable or disable the serial port.

→	Disabled		Disable the serial port
→	Enabled	DEFAULT	Enable the serial port

→ Change Settings [Auto]

Use the **Change Settings** option to change the serial port IO port address and interrupt address.

→	Auto	DEFAULT	The serial port IO port address and interrupt address are automatically detected.
→	IO=2F8h; IRQ=3		Serial Port I/O port address is 2F8h and the interrupt address is IRQ3
→	IO=3F8h; IRQ=3, 4		Serial Port I/O port address is 3F8h and the interrupt address is IRQ3, 4
→	IO=2F8h; IRQ=3, 4		Serial Port I/O port address is 2F8h and the interrupt address is IRQ3, 4
→	IO=2C0h; IRQ=3, 4		Serial Port I/O port address is 2C0h and the interrupt address is IRQ3, 4





→ IO=2C8h; IRQ=3, 4 Serial Port I/O port address is 2C8h and the interrupt address is IRQ3, 4

4.3.6.1.3 Serial Port 3 Configuration

→ Serial Port [Enabled]

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Use the Serial Port option to enable or disable the serial port.

Disabled Disable the serial port
 Enabled DEFAULT Enable the serial port

→ Change Settings [Auto]

Use the **Change Settings** option to change the serial port IO port address and interrupt address.

→	Auto	DEFAULT	The serial port IO port address and interrupt address are automatically detected.
→	IO=3E8h; IRQ=10		Serial Port I/O port address is 3E8h and the interrupt address is IRQ10
→	IO=3E8h; IRQ=10, 11		Serial Port I/O port address is 3E8h and the interrupt address is IRQ10, 11
→	IO=2E8h; IRQ=10, 11		Serial Port I/O port address is 2E8h and the interrupt address is IRQ10, 11
→	IO=2D0h; IRQ=10, 11		Serial Port I/O port address is 2D0h and the interrupt address is IRQ10, 11
→	IO=2D8h; IRQ=10, 11		Serial Port I/O port address is 2D8h and the interrupt address is IRQ10, 11

4.3.6.1.4 Serial Port 4 Configuration

→ Serial Port [Enabled]

Use the Serial Port option to enable or disable the serial port.

→	Disabled		Disable the serial port
→	Enabled	DEFAULT	Enable the serial port

→ Change Settings [Auto]

Use the **Change Settings** option to change the serial port IO port address and interrupt address.

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→	Auto	DEFAULT	The serial port IO port address and interrupt address are automatically detected.
→	IO=2E8h; IRQ=10		Serial Port I/O port address is 2E8h and the interrupt address is IRQ10
→	IO=3E8h; IRQ=10, 11		Serial Port I/O port address is 3E8h and the interrupt address is IRQ10, 11
→	IO=2E8h; IRQ=10, 11		Serial Port I/O port address is 2E8h and the interrupt address is IRQ10, 11
→	IO=2D0h; IRQ=10, 11		Serial Port I/O port address is 2D0h and the interrupt address is IRQ10, 11
→	IO=2D8h; IRQ=10, 11		Serial Port I/O port address is 2D8h and the interrupt address is IRQ10, 11





4.3.7 H/W Monitor

The **H/W Monitor** menu (**BIOS Menu 10**) shows the operating temperature, fan speeds and system voltages.

Aptio Setup Utility Advanced	- Copyright (C) 2010 Americ	an Megatrends, Inc.
PC Health Status	:+45 C	
CPU Temperature SYS Temperature	:+45 C :+40 C :N/A	
CPU FAN Speed VCC3V	:N/A :+3.312 V :+1.152 V	
V_core Vcc	:+5.045 V	
Vcc12 Vcc1_5VDDR	:+12.056 V :+1.488 V	←→: Select Screen ↑↓: Select Item
VSB3V VBAT	:+3.328 V :+3.216 V	EnterSelect + - Change Opt.
CPU Smart Fan control Temperature Bound 1	[Auto Mode] 60	F1 General Help F2 Previous Values
Temperature Bound 2 Temperature Bound 3	50 40	F3 Optimized Defaults F4 Save & Exit
Temperature Bound 4	30 Copyright (C) 2010 America	ESC Exit

BIOS Menu 10: H/W Monitor

→ PC Health Status

The following system parameters and values are shown. The system parameters that are monitored are:

- System Temperatures:
 - O CPU Temperature
 - O System Temperature
- Fan Speeds:
 - O CPU Fan Speed
- Voltages:
 - O VCC3V
 - O Vcore
 - O Vcc
 - O Vcc12

- O Vcc1_5VDDR
- O VSB3V
- O VBAT

→ CPU Smart Fan control [Auto Mode]

Use the CPU Smart Fan control option to configure the CPU fan.

→	Auto Mode	DEFAULT	The fan adjusts its speed using these settings:
			Temperature Bound 1
			Temperature Bound 2
			Temperature Bound 3
			Temperature Bound 4
→	Manual Mode		The fan spins at the speed set in: Manual Duty Cycle Setting

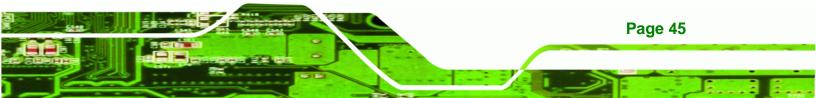
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→ Temperature Bound n

Use the + or - key to change the fan **Temperature Bound n** value. Enter a decimal number between 0 and 127.

4.3.8 Serial Port Console Redirection

The **Serial Port Console Redirection** menu (**BIOS Menu 11**) allows the console redirection options to be configured. Console redirection allows users to maintain a system remotely by re-directing keyboard input and text output through the serial port.



Aptio Setup Utility - Cop	yright (C) 2010 America	n Megatrends, Inc.
Advanced		
COM1		Console Redirection
Console Redirection	[Disabled]	Enable or Disable
> Console Redirection Settings		
COM2		
Console Redirection	[Disabled]	
> Console Redirection Settings		
COM3		
Console Redirection	[Disabled]	
> Console Redirection Settings	[DISADIEU]	
		$\leftarrow \rightarrow$: Select Screen
COM4		↑↓: Select Item
Console Redirection	[Disabled]	EnterSelect
> Console Redirection Settings		+/-: Change Opt.
		F1 General Help
		F2 Previous Values
		F3 Optimized Defaults
		F4 Save & Exit
		ESC Exit
Version 2.02.1205. Copyr	right (C) 2010 American	Megatrends, Inc.

BIOS Menu 11: Serial Port Console Redirection

→ Console Redirection [Disabled]

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Use **Console Redirection** option to enable or disable the console redirection function.

→	Disabled	DEFAULT	Disabled the console redirection function
→	Enabled		Enabled the console redirection function

→ Terminal Type [ANSI]

Use the **Terminal Type** option to specify the remote terminal type.

→	VT100		The target terminal type is VT100
→	VT100+		The target terminal type is VT100+
→	VT-UTF8		The target terminal type is VT-UTF8
→	ANSI	DEFAULT	The target terminal type is ANSI

→ Bits per second [115200]

Use the **Bits per second** option to specify the serial port transmission speed. The speed must match the other side. Long or noisy lines may require lower speeds.

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→	9600		Sets the serial port transmission speed at 9600.
→	19200		Sets the serial port transmission speed at 19200.
→	38400		Sets the serial port transmission speed at 38400.
→	57600		Sets the serial port transmission speed at 57600.
→	115200	DEFAULT	Sets the serial port transmission speed at 115200.

4.4 Chipset

Use the **Chipset** menu (**BIOS Menu 12**) to access the Northbridge and Southbridge configuration menus.



Setting the wrong values for the Chipset BIOS selections in the Chipset BIOS menu may cause the system to malfunction.

Aptio Setup Utility - Copyright (C) 2010 America Main Advanced Chipset Boot Security Save	_
<pre>> Host Bridge > South Bridge > Intel IGD SWSCI OpRegion</pre>	North Bridge Parameters
	<pre></pre>
Version 2.02.1205. Copyright (C) 2010 American	Megatrends, Inc.

BIOS Menu 12: Chipset





4.4.1 Host Bridge Configuration

Use the **Host Bridge Configuration** menu (**BIOS Menu 13**) to configure the Northbridge chipset.

Aptio Setup Utility - Cop Chipset	pyright (C) 2010 America	an Megatrends, Inc.
> OnChip VGA Configuration		Config On Chip VGA Settings.
Initate Graphic Adapter	[PCI/IGD]	
****** Memory Information ***	* * * *	
Memory Frequency	800 Mhz	\leftrightarrow : Select Screen
Total Memory	1024 MB	<pre>↑ ↓: Select Item EnterSelect + - Change Opt.</pre>
DIMM#0	1024 MB	F1 General Help
DIMM#1	Not Present	F2 Previous Values
		F3 Optimized Defaults
		F4 Save & Exit
		ESC Exit
Version 2.02.1205. Copy	right (C) 2010 American	Megatrends, Inc.

→ Initiate Graphic Adapter [PCI/IGD]

Use the **Initiate Graphic Adapter** option to select the graphics controller used as the primary boot device. Select either an integrated graphics controller (IGD) or a combination of PCI graphics controller. Configuration options are listed below:

- IGD
- PCI/IGD DEFAULT



BIOS Menu 13: Host Bridge Chipset Configuration

4.4.1.1 OnChip VGA Configuration

Use the **OnChip VGA Configuration** menu (**BIOS Menu 14**) to configure the OnChip VGA.

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Aptio Setup Utility Chips		2010 American	n Megatrends, Inc.
OnChip VGA Configuration			Select Share Memory Size.
Share Memory Size	[8 MB]		
			<pre>←→: Select Screen ↑↓: Select Item EnterSelect + - Change Opt. F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save & Exit ESC Exit</pre>
Version 2.02.1205.	Copyright (C) 2	2010 American	Megatrends, Inc.

BIOS Menu 14: OnChip VGA Configuration

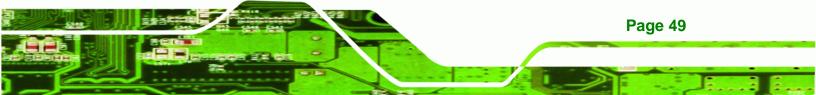
→ Share Memory Size [8 MB]

Use the **Share Memory Size** option to set the amount of system memory allocated to the integrated graphics processor when the system boots. The system memory allocated can then only be used as graphics memory, and is no longer available to applications or the operating system. Configuration options are listed below:

- Disabled
- 8 MB Default

4.4.2 South Bridge Configuration

Use the **South Bridge Configuration** menu (**BIOS Menu 15**) to configure the Southbridge chipset.



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TANK-101B/BW Embedded System

Aptio Setup Utility - Co Chipset	opyright (C) 2010 Ame	erican Megatrends, Inc.
Auto Power Button Function HD Audio Controller USB Function USB 2.0(EHCI) Support Set Spread Spectrum function	[Enabled] [Enabled] [Enabled] [Disabled]	High Definition Audio Controller
Version 2.02.1205. Cop	yright (C) 2010 Amer	rican Megatrends, Inc.

BIOS Menu 15: South Bridge Chipset Configuration

→ Restore AC Power Loss [Last State]

Use the **Restore AC Power Loss** BIOS option to specify what state the system returns to if there is a sudden loss of power to the system.

→	Power Off		The system remains turned off
→	Power On		The system turns on
→	Last State	DEFAULT	The system returns to its previous state. If it was on, it
			turns itself on. If it was off, it remains off.

→ HD Audio Controller [Enabled]

Use the **HD** Audio Controller option to enable or disable the High Definition Audio controller.

→	Enabled	DEFAULT	The	onboard	High	Definition	Audio	controller
			autor	natically def	ected a	nd enabled		
→	Disabled		The c	onboard Hig	h Defini	tion Audio co	ontroller i	s disabled

→ USB Function [Enabled]

Use the **USB Function** BIOS option to enable or disable USB function support.



➔ Disa	bled	USB function support disabled
--------	------	-------------------------------

Enabled DEFAULT USB function support enabled

→ USB 2.0 (EHCI) Support [Enabled]

Use the USB 2.0 (EHCI) Support BIOS option to enable or disable USB 2.0 support.

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→	Enabled	DEFAULT	USB 2.0 (EHCI) support enabled
---	---------	---------	--------------------------------

Disabled
 USB 2.0 (EHCI) support disabled

→ Set Spread Spectrum Function [Disabled]

The Set Spread Spectrum Function option can help to improve CPU EMI issues.

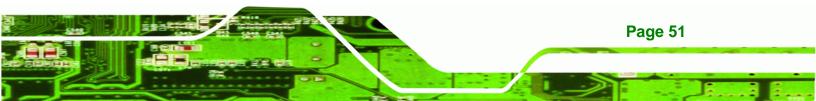
→	Disabled	DEFAULT	The spread spectrum mode is disabled
→	Enabled		The spread spectrum mode is enabled

4.4.3 Intel IGD SWSCI OpRegion

Use the **Intel IGD SWSCI OpRegion** menu (**BIOS Menu 16**) to configure the video device connected to the system.

Aptio Setup Utility - Copy Chipset	right (C) 2010 America	n Megatrends, Inc.
Intel IGD SWSCI OpRegion Configu DVMT Mode Select DVMT/Fixed Memory	uration [DVMT Mode] [Maximum]	Select DVMT Mode/Fixed Mode
		<pre>←→: Select Screen ↑↓: Select Item EnterSelect + - Change Opt. F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save & Exit ESC Exit</pre>
Version 2.02.1205. Copyr:	ight (C) 2010 American	Megatrends, Inc.

BIOS Menu 16: Intel IGD SWSCI OpRegion Configuration



➔ DVMT Mode Select [DVMT Mode]

Use the **DVMT Mode Select** option to select the Intel Dynamic Video Memory Technology (DVMT) operating mode.

→	Fixed Mode	A fixed portion of graphics memory is reserved as
		graphics memory.

DVMT Mode DEFAULT Graphics memory is dynamically allocated according to the system and graphics needs.

→ DVMT/FIXED Memory [Maximum]

Use the **DVMT/FIXED Memory** option to specify the maximum amount of memory that can be allocated as graphics memory. Configuration options are listed below.

- 128 MB
- 256 MB
- Maximum **Default**

4.5 Boot

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Use the Boot menu (BIOS Menu 17) to configure system boot options.

		merican Megatrends, Inc.
Main Advanced Chipset	Boot Security	Save & Exit
Boot Configuration Boot NumLock State	[On]	Select the keyboard NumLock state
Quiet Boot Launch PXE OpROM	[Enabled] [Disabled]	←→: Select Screen
Boot Option Priorities		<pre>↑↓: Select Item EnterSelect + - Change Opt. F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save & Exit ESC Exit</pre>
Version 2.02.1205. C	opyright (C) 2010 Ame	rican Megatrends, Inc.

BIOS Menu 17: Boot

➔ Bootup NumLock State [On]

Use the **Bootup NumLock State** BIOS option to specify if the number lock setting must be modified during boot up.

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- ➤ On DEFAULT Allows the Number Lock on the keyboard to be enabled automatically when the computer system boots up. This allows the immediate use of the 10-key numeric keypad located on the right side of the keyboard. To confirm this, the Number Lock LED light on the keyboard is lit.
- ➔ Off Does not enable the keyboard Number Lock automatically. To use the 10-keys on the keyboard, press the Number Lock key located on the upper left-hand corner of the 10-key pad. The Number Lock LED on the keyboard lights up when the Number Lock is engaged.

→ Quiet Boot [Enabled]

Use the **Quiet Boot** BIOS option to select the screen display when the system boots.

→	Disabled		Normal POST messages displayed
→	Enabled	DEFAULT	OEM Logo displayed instead of POST messages

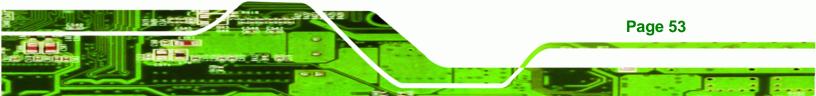
→ Launch PXE OpROM [Disabled]

Use the **Launch PXE OpROM** option to enable or disable boot option for legacy network devices.

Disabled DEFAULT Ignore all PXE Option ROMs
 Enabled Load PXE Option ROMs.

4.6 Security

Use the Security menu (BIOS Menu 18) to set system and user passwords.



Aptio Setup Utility - Copyright (C) 2010 America	n Megatrends, Inc.
Main Advanced Chipset Boot <mark>Security</mark> Save	& Exit
Password Description	Set Setup Administrator
If ONLY the Administrator's password is set,	Password
then this only limits access to Setup and is only asked for when entering Setup. If ONLY the User's password is set, then this is a power on password and must be entered to boot or enter Setup. In Setup the User will have Administrator rights. The password must be 3 to 20 characters long.	<pre>←→: Select Screen ↑↓: Select Item EnterSelect + - Change Opt. F1 General Help</pre>
Administrator Password User Password Version 2.02.1205. Copyright (C) 2010 American	F2 Previous Values F3 Optimized Defaults F4 Save & Exit ESC Exit

BIOS Menu 18: Security

➔ Administrator Password

Use the Administrator Password to set or change a administrator password.

➔ User Password

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Use the User Password to set or change a user password.



4.7 Exit

Use the **Exit** menu (**BIOS Menu 19**) to load default BIOS values, optimal failsafe values and to save configuration changes.

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Aptio Setup Utility -	Copyright	(C) 2010 Am	erican	n Megatrends, Inc.
Main Advanced Chipset	Boot	Security	Save	& Exit
Save Changes and Reset Discard Changes and Reset				Exit the system after saving the changes.
Restore Defaults Save as User Defaults Restore User Defaults				
				<pre>←→: Select Screen ↑↓: Select Item EnterSelect + - Change Opt. F1 General Help F2 Previous Values</pre>
				F3 Optimized Defaults F4 Save & Exit ESC Exit
Version 2.02.1205. C	opyright (C) 2010 Amei	rican l	Megatrends, Inc.

BIOS Menu 19:Exit

→ Save Changes and Reset

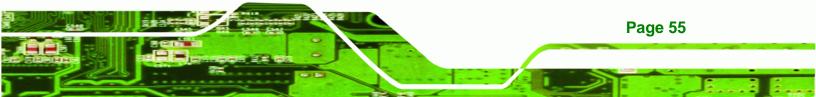
Use the **Save Changes and Reset** option to save the changes made to the BIOS options and to exit the BIOS configuration setup program.

➔ Discard Changes and Reset

Use the **Discard Changes and Reset** option to exit the system without saving the changes made to the BIOS configuration setup program.

→ Restore Defaults

Use the **Restore Defaults** option to load the optimal default values for each of the parameters on the Setup menus. **F3 key can be used for this operation.**





→ Save as User Defaults

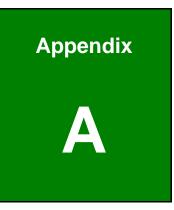
Use the Save as User Defaults option to save the changes done so far as user defaults.

→ Restore User Defaults

Use the **Restore User Defaults** option to restore the user defaults to all the setup options.

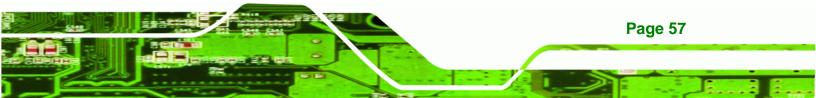






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One Key Recovery





A.1 One Key Recovery Introduction

The IEI one key recovery is an easy-to-use front end for the Norton Ghost system backup and recovery tool. The one key recovery provides quick and easy shortcuts for creating a backup and reverting to that backup or for reverting to the factory default settings.

The IEI One Key Recovery tool menu is shown below.

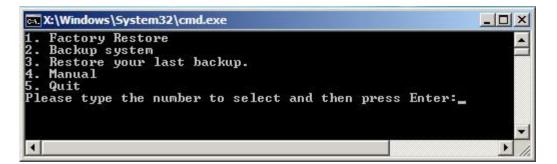


Figure A-1: IEI One Key Recovery Tool Menu

Prior to using the IEI One Key Recovery tool (as shown in **Figure A-1**) to backup or restore <u>Windows</u> system, five setup procedures are required.

- 1. Hardware and BIOS setup (see Section A.2.1)
- 2. Create partitions (see Section A.2.2)
- 3. Install operating system, drivers and system applications (see Section A.2.3)
- 4. Build-up recovery partition (see Section A.2.4)
- 5. Create factory default image (see Section A.2.5)

After completing the five initial setup procedures as described above, users can access the recovery tool by pressing **<F3>** while booting up the system. The detailed information of each function is described in **Section A.4**.



The initial setup procedures for Linux system are described in **Section A.3**.

A.1.1 System Requirement



The recovery CD can only be used with IEI products. The software will fail to run and a warning message will appear when used on non-IEI hardware.



To create the system backup, the main storage device must be split into two partitions (three partitions for Linux). The first partition will be for the operating system, while the second partition will be invisible to the operating system and contain the backup made by the one key recovery software.

The partition created for recovery images must be big enough to contain both the factory default image and the user backup image. The size must be calculated before creating the partitions. Please take the following table as a reference when calculating the size of the partition.

	os	OS Image after Ghost	Compression Ratio
Windows® 7	7 GB	5 GB	70%
Windows® XPE	776 MB	560 MB	70%
Windows® CE 6.0	36 MB	28 MB	77%



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Specialized tools are required to change the partition size if the operating system is already installed.

A.1.2 Supported Operating System

The recovery CD is compatible with both Microsoft Windows and Linux operating system (OS). The supported OS versions are listed below.

- Microsoft Windows
 - O Windows XP (Service Pack 2 or 3 required)
 - O Windows Vista
 - O Windows 7
 - O Windows CE 5.0
 - O Windows CE 6.0
 - O Windows XP Embedded
- Linux
 - O Fedora Core 12 (Constantine)
 - O Fedora Core 11 (Leonidas)
 - O Fedora Core 10 (Cambridge)
 - O Fedora Core 8 (Werewolf)
 - O Fedora Core 7 (Moonshine)
 - O RedHat RHEL-5.4
 - O RedHat 9 (Ghirke)
 - O Ubuntu 8.10 (Intrepid)
 - O Ubuntu 7.10 (Gutsy)
 - O Ubuntu 6.10 (Edgy)
 - O Debian 5.0 (Lenny)
 - O Debian 4.0 (Etch)
 - O SuSe 11.2
 - O SuSe 10.3



Installing unsupported OS versions may cause the recovery tool to fail.

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A.2 Setup Procedure for Windows

Prior to using the recovery tool to backup or restore Windows system, a few setup procedures are required.

- Step 1: Hardware and BIOS setup (see Section A.2.1)
- Step 2: Create partitions (see Section A.2.2)
- Step 3: Install operating system, drivers and system applications (see Section A.2.3)
- Step 4: Build-up recovery partition (see Section A.2.4)
- Step 5: Create factory default image (see Section A.2.5)

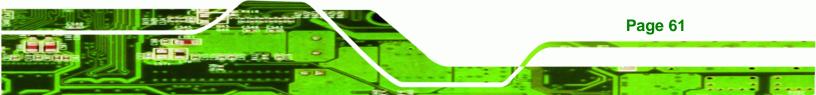
The detailed descriptions are described in the following sections.



The setup procedures described below are for Microsoft Windows operating system users. For Linux system, most setup procedures are the same with Microsoft Windows except for several steps described in **Section A.3**.

A.2.1 Hardware and BIOS Setup

- Step 1: Make sure the system is powered off and unplugged.
- **Step 2:** Install a hard drive or SSD in the system. An unformatted and unpartitioned disk is recommended.
- Step 3: Connect an optical disk drive to the system and insert the recovery CD.



Step 4: Turn on the system.

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- Step 5: Press the <DELETE> key as soon as the system is turned on to enter the BIOS.
- **Step 6:** Select the connected optical disk drive as the 1st boot device. (**Boot** \rightarrow **Boot Device Priority** \rightarrow 1st **Boot Device**).
- Step 7: Save changes and restart the computer. Continue to the next section for instructions on partitioning the internal storage.

A.2.2 Create Partitions

To create the system backup, the main storage device must be split into two partitions (three partitions for Linux). The first partition will be for the operating system, while the second partition will be invisible to the operating system and contain the backup made by the one key recovery software.

- Step 1: Put the recovery CD in the optical drive of the system.
- Step 2: Boot the system from recovery CD. When prompted, press any key to boot from the recovery CD. It will take a while to launch the recovery tool. Please be patient!



Figure A-2: Launching the Recovery Tool

Step 3: The recovery tool setup menu is shown as below.

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.Ghost	Execution		
.System	Configuration	For	Windows
	Configuration	For	Linux
L.Exit			
CMD			
ype the	number to prin	nt te	ext

Figure A-3: Recovery Tool Setup Menu

Step 4: Press <5> then <Enter>.

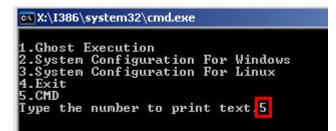


Figure A-4: Command Mode

 Step 5:
 The command prompt window appears. Type the following commands (marked in red) to create two partitions. One is for the OS installation; the other is for saving recovery files and images which will be an invisible partition.

 (Press <Enter> after entering each line below)

 system32>diskpart

 DISKPART>list vol

 DISKPART>sel disk 0

 DISKPART>create part pri size= ____

 DISKPART>create part pri size= _____

 DISKPART>create part pri size= _____

 DISKPART>create part pri size= _____

 DISKPART>create part pri size= ______

 DISKPART>create part pri size= ______

 DISKPART>create part pri size= _______

 DISKPART>create part pri size= _______

 DISKPART>create part pri size= ________

 DISKPART>create part pri size= _________

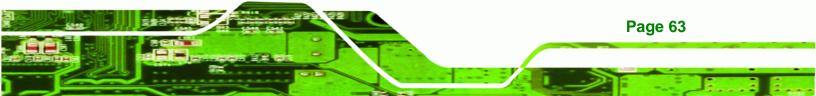
 DISKPART>create part pri size= _________

 DISKPART>create part pri size= __________

 DISKPART>create part pri size= ___________

 DISKPART>create part pri size= _______________

 DISKPART>create part pri size= ____________





system32>format F: /fs:ntfs /q /v:Recovery /y

system32>exit

👞 X:\I386\system	n32\CM	D.EXE					_ 8	×
X:\I386\SYSTE	M32>d	iskpart 🔶	Starts th	e Microsoft dis	k partitioni	ng tool.		
Microsoft Dis Copyright (C) On computer:	1999	-2001 Microso	.3790.18 oft Corp	30 poration.				
DISKPART> lis	t vol	→ Show pa	rtition in	formation				
Volume ###	Ltr	Labe 1	Fs	Туре	Size	Status	Info	
Volume Ø Volume 1	X D	CD_ROM	CDFS FAT32		405 MB 3854 MB	Healthy Healthy	Boot	
DISKPART> sel	disk	0	t a disk					
Disk Ø is now								
DISKPART> cre	ate p	art pri size=	2000 -	Create pa This parti	rtition 1 an tion is for (d assign a s OS installatio	ize. on.	
DiskPart succ								
DISKPART> ass	ign l	etter=N	Assign p	partition 1 a co	de name (N			
DiskPart succ	essfu	lly assigned	the dri	ve letter or	mount po	int.		
DISKPART> cre	ate p	art pri size=	-1800	Create partition This partition	rtition 2 and	d assign a si ecoverv ima	ze. des.	
DiskPart succ							9	
DISKPART> ass	ign l	etter=F	Assign	partition 2 a co	de name (F	·).		
DiskPart succ	essfu	lly assigned	the dri	ve letter or	mount po	int.		
DISKPART> exi	t	Exit diskpart						
X:\l386\SYSTE The type of t The new file QuickFormatti Creating file Format comple 2048254 KB 2035620 KB	he fi syste ng 20 syst te. tota	le system is m is NTFS. 00M em structures 1 disk space.	кн w .	r ∠y <mark>→ Forn</mark>	mat partitio	n 1 (N) as N	TFS format.	
X:\I386\SYSTE The type of t The new file QuickFormatti Creating file Format comple 1847474 KB 1835860 KB X:\I386\SYSTE	he fi syste ng 18 syst te. tota are	ie system is m is NTFS. 04M em structures l disk space. available.	лнw.	Formate par name it as "		as NTFS for	mate and	
V: 1380/2121F	nszze.	XIC ALC						

Figure A-5: Partition Creation Commands





Use the following commands to check if the partitions were created successfully.

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	on.
Size	Offset
2000 MB 1804 MB	
	2000 MB

Step 6: Press any key to exit the recovery tool and automatically reboot the system. Please continue to the following procedure: Build-up Recovery Partition.

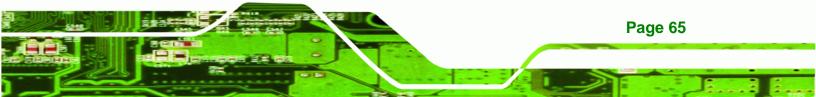
A.2.3 Install Operating System, Drivers and Applications

Install the operating system onto the unlabelled partition. The partition labeled as "Recovery" is for use by the system recovery tool and should not be used for installing the operating system or any applications.



The operating system installation program may offer to reformat the chosen partition. DO NOT format the partition again. The partition has already been formatted and is ready for installing the new operating system.

To install the operating system, insert the operating system installation CD into the optical drive. Restart the computer and follow the installation instructions.





A.2.4 Build-up Recovery Partition

- **Step 1:** Put the recover CD in the optical drive.
- Step 2: Start the system.
- Step 3: Boot the system from recovery CD. When prompted, press any key to boot from the recovery CD. It will take a while to launch the recovery tool. Please be patient!

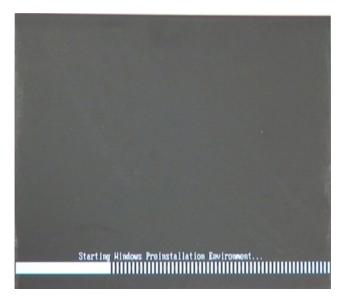
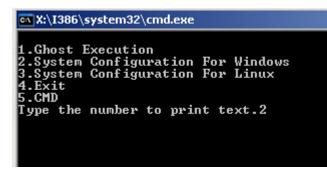


Figure A-6: Launching the Recovery Tool

Step 4: When the recovery tool setup menu appears, press <2> then <Enter>.





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Step 5: The Symantec Ghost window appears and starts configuring the system to

build-up a recovery partition. In this process, the partition which is created for

recovery files in Section A.2.2 is hidden and the recovery tool is saved in this

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partition.

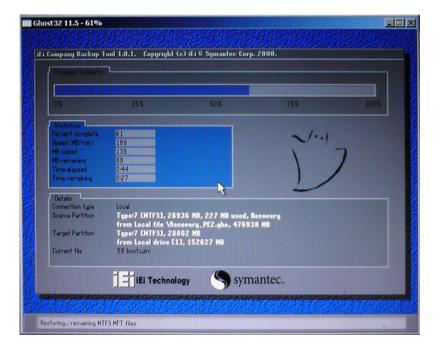


Figure A-8: Build-up Recovery Partition

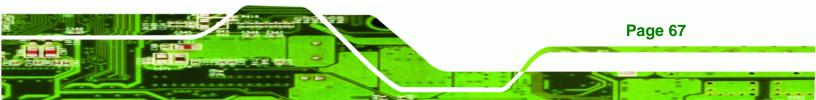
Step 6: After completing the system configuration, press any key in the following window

to reboot the system.

Ghost Execution System Configuration For Windows System Configuration For Linux Exit
System Configuration For Linux Exit
CMD

Figure A-9: Press any key to continue

Step 7: Eject the recovery CD.





A.2.5 Create Factory Default Image



Before creating the factory default image, please configure the system to a factory default environment, including driver and application installations.

To create a factory default image, please follow the steps below.

Step 1: Turn on the system. When the following screen displays (Figure A-10), press the <F3> key to access the recovery tool. The message will display for 10 seconds, please press F3 before the system boots into the operating system.

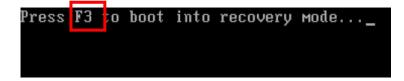


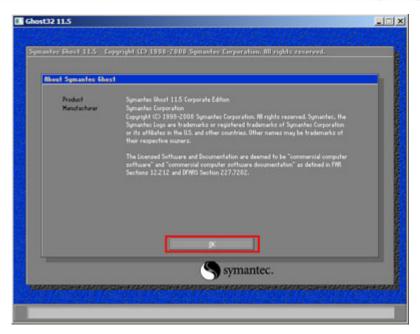
Figure A-10: Press F3 to Boot into Recovery Mode

Step 2: The recovery tool menu appears. Type <4> and press <Enter>. (Figure A-11)



Figure A-11: Recovery Tool Menu

Step 3: The About Symantec Ghost window appears. Click OK button to continue.



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Figure A-12: About Symantec Ghost Window

Step 4: Use mouse to navigate to the option shown below (Figure A-13).

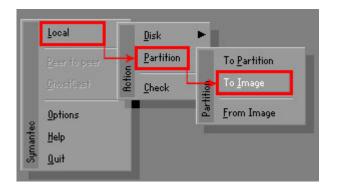
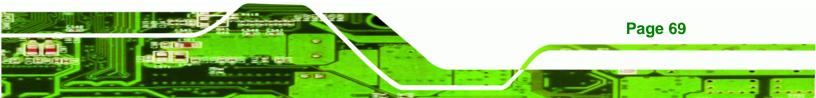


Figure A-13: Symantec Ghost Path

Step 5: Select the local source drive (Drive 1) as shown in Figure A-14. Then click OK.





Drive	Location	Model	Size(MB)	Type	Cylinders	Heads	Sectors
1	Local	ST3160318AS	152627	Balsic	19457	255	63
80	Local	US Volumes	120128	Basic	15314	255	63

Figure A-14: Select a Local Source Drive

Step 6: Select a source partition (Part 1) from basic drive as shown in Figure A-15.

Then click OK.

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Part	Type	Letter	ID	Description	Volume Label	Size in MB	Data Size in MB
1	C)		07	NTFS	No name	100006	1951
2	0:		07	NIFS	Necovery Free	20002 32618	a11
					Total	152627	2178



Step 7: Select 1.2: [Recovery] NTFS drive and enter a file name called iei

(**Figure A-16**). Click **Save**. The factory default image will then be saved in the selected recovery drive and named IEI.GHO.



The file name of the factory default image must be **iei.GHO**.



D: 1 2: FBaaa	uoru] NTES dei		
D: I.E. Eneco			
	oize		
formation		12/31/2001	11:07:28 PM
el		3	Save
el *.GHO		3	<u>Save</u>
	D: 1.2: [Reco	Size	01/03/2010 01/03/2010 01/03/2010 01/03/2010 01/03/2010

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Figure A-16: File Name to Copy Image to

Step 8: When the Compress Image screen in Figure A-17 prompts, click High to make

the image file smaller.

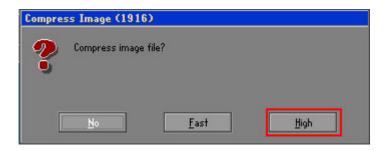


Figure A-17: Compress Image





Step 9: The Proceed with partition image creation window appears, click Yes to

continue.

Questio	n: (1837)
?	Proceed with partition image creation?
	<u>Y</u> es <u>N</u> o

Figure A-18: Image Creation Confirmation

Progress Indicator				
0%	25%	50%	75%	100%
Statistics	52			
Percent complete Speed (MB/min)	468		~	
MB copied	632			
MB remaining	563		1	1
Time elapsed	1:21			1
Time remaining	1:12			/
Details				
Connection type	Local			
Source Partition	Type:7 [NTFS], 100	0006 MB, 1951 MB used	l, No name	
	from Local drive [8	0], 130129 MB		
Destination file	Local file D:\iei.6HO			
Current file	3891 c_869.nls			

Step 10: The Symantec Ghost starts to create the factory default image (Figure A-19).

Figure A-19: Image Creation Process

Step 11: When the image creation completes, a screen prompts as shown in Figure A-20.

Click **Continue** and close the Ghost window to exit the program.

Image	Creation Complete (1925)
2	Image Creation Completed Successfully
	Continue

Figure A-20: Image Creation Complete

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Step 12: The recovery tool main menu window is shown as below. Press any key to

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reboot the system.

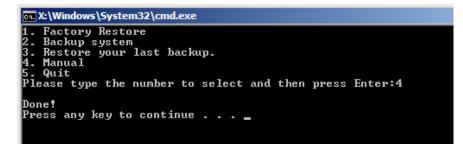


Figure A-21: Press Any Key to Continue

A.3 Setup Procedure for Linux

The initial setup procedures for a Linux system are mostly the same with the procedure for Microsoft Windows. Please follow the steps below to setup the recovery tool for Linux OS.

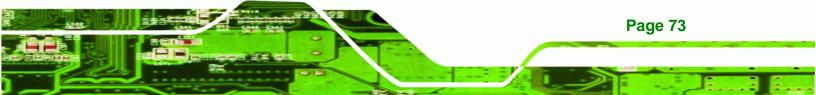
- Step 1: Hardware and BIOS setup. Refer to Section A.2.1.
- Step 2: Install Linux operating system. Make sure to install GRUB (v0.97 or earlier) MBR type and Ext3 partition type. Leave enough space on the hard drive to create the recover partition later.



If the Linux OS is not installed with GRUB (v0.97 or earlier) and Ext3, the Symantec Ghost may not function properly.

While installing Linux OS, please create two partitions:

- Partition 1: I
- Partition 2: SWAP







Please reserve enough space for partition 3 for saving recovery images.

Partition 1	Partition 2	* Recovery Partit	tion 3
s/hda1	s/hda2	s/hda3	()
•Point : /	•Type : SWAP	•Recovery Mode	
•Type : Ext3		•Recovery Image	\searrow

Figure A-22: Partitions for Linux

- Step 3: Create a recovery partition. Insert the recovery CD into the optical disk drive. Follow Step 1 ~ Step 3 described in Section A.2.2. Then type the following commands (marked in red) to create a partition for recovery images. system32>diskpart DISKPART>list vol DISKPART>sel disk 0 DISKPART>create part pri size= ____ DISKPART>assign letter=N DISKPART>exit system32>format N: /fs:ntfs /q /v:Recovery /y system32>exit
- Step 4: Build-up recovery partition. Press any key to boot from the recovery CD. It will take a while to launch the recovery tool. Please be patient. When the recovery tool setup menu appears, type <3> and press <Enter> (Figure A-23). The Symantec Ghost window appears and starts configuring the system to build-up a recovery partition. After completing the system configuration, press any key to reboot the system. Eject the recovery CD.





X:\I386\system32\cmd.exe 1.Ghost Execution 2.System Configuration For Windows 3.System Configuration For Linux 4.Exit 5.CMD Type the number to print text.3



Step 5: Access the recovery tool main menu by modifying the "menu.lst". To first

access the recovery tool main menu, the menu.lst must be modified. In Linux

system, enter Administrator (root). When prompt appears, type:

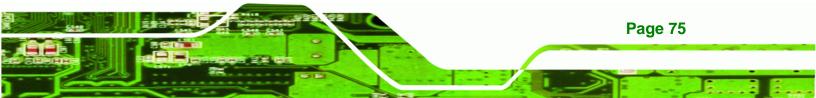
cd /boot/grub

vi menu.lst

		9 (Sulphur 4.fc9.i686	i686	(tty2)
localh Passwoi	ost login rd:	: root		
		~]# cd ∕b grub]# vi		

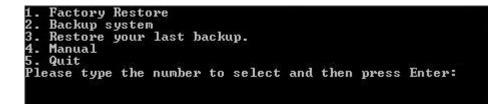
Figure A-24: Access menu.lst in Linux (Text Mode)

Step 6: Modify the menu.lst as shown below.





Step 7: The recovery tool menu appears. (Figure A-25)





Step 8: Create a factory default image. Follow Step 2 ~ Step 12 described in Section

A.2.5 to create a factory default image.

A.4 Recovery Tool Functions

After completing the initial setup procedures as described above, users can access the recovery tool by pressing $\langle F3 \rangle$ while booting up the system. The main menu of the recovery tool is shown below.

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👞 X:\Windows\System32\cmd.exe	- O ×
1. Factory Restore 2. Backup system 3. Restore your last backup. 4. Manual 5. Quit Please type the number to select and then press Enter:_	
<u>۱</u>	 ✓ ✓

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Figure A-26: Recovery Tool Main Menu

The recovery tool has several functions including:

- 1. **Factory Restore**: Restore the factory default image (iei.GHO) created in Section A.2.5.
- Backup system: Create a system backup image (iei_user.GHO) which will be saved in the hidden partition.
- 3. Restore your last backup: Restore the last system backup image
- 4. Manual: Enter the Symantec Ghost window to configure manually.
- 5. Quit: Exit the recovery tool and restart the system.



Please do not turn off the system power during the process of system recovery or backup.



All data in the system will be deleted during the system recovery. Please backup the system files before restoring the system (either Factory Restore or Restore Backup).





A.4.1 Factory Restore

To restore the factory default image, please follow the steps below.

- Step 1: Type <1> and press <Enter> in the main menu.
- Step 2: The Symantec Ghost window appears and starts to restore the factory default. A

factory default image called **iei.GHO** is created in the hidden Recovery partition.

0%	25%	50%	75%	100%
Statistics				
Percent complete	45		- 1.1	
Speed (MB/min)	1125		~	
MB copied	544		1	-7
MB remaining	651		1	1
Time elapsed	0:29		1	/
Time remaining	0:34			·
Details				
Connection type	Local			
Source Partition		0006 MB, 1951 MB used iei.gho, 130129 MB	, No name	
Target Partition	Type:7 ENTFS], 10	0006 MB		
	from Local drive [1], 152627 MB		
Current file	3279 xpob2res.dll			

Figure A-27: Restore Factory Default

Step 3: The screen is shown as in Figure A-28 when completed. Press any key to

reboot the system.

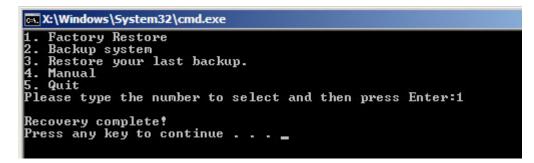


Figure A-28: Recovery Complete Window

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A.4.2 Backup System

To backup the system, please follow the steps below.

- **Step 4:** Type <**2**> and press <**Enter**> in the main menu.
- Step 5: The Symantec Ghost window appears and starts to backup the system. A

backup image called **iei_user.GHO** is created in the hidden Recovery partition.

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nantec Ghost 11.5	Copyright (C) 1998	-2008 Symantec Corpora	tion. All rights reserved	
Progress Indicator				
0%	25%	50%	75%	100%
Statistics				
Percent complete	45		- 1.1	
Speed (MB/min)	212			
MB copied	548		1	7
MB remaining	647		1	1
Time elapsed	2:35			/
Time remaining	3:03			
Details			-	
Connection type	Local			
Source Partition	Type:7 [NTFS], 10	0006 MB, 1951 MB used,	, No name	
	from Local drive [1	IJ, 152627 MB		
Destination file	Local file D:\iei_us	er.gho		
0 10	0000 LO III			
Current file	3288 xpob2res.dll			
		(Syma	antec.	

Figure A-29: Backup System

Step 6: The screen is shown as in Figure A-30 when system backup is completed.

Press any key to reboot the system.

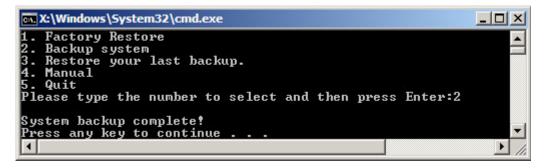
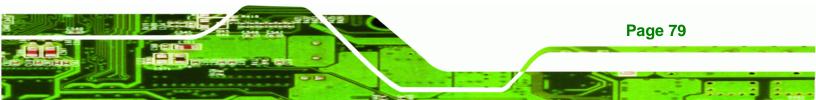


Figure A-30: System Backup Complete Window





A.4.3 Restore Your Last Backup

To restore the last system backup, please follow the steps below.

- Step 1: Type <3> and press <Enter> in the main menu.
- Step 2: The Symantec Ghost window appears and starts to restore the last backup

image (iei_user.GHO).

*	50%	75%	л., 7	100%
2	50%	75%	»., 7	100%
	50%	75%	/ 7	100%
		Ì	^{7.1} 7	
		Ì	7.1	
		Ì	7	
			7	
		1		
		1		
ENTFS]. 100006 MB.	1951 MB used	. No name		
ob2res.dll				
		antac		
0		ocal drive [1], 152627 HB ile D:\iei_user.gho oob2res.dl	ile D:\iei_user.gho	ocal drive E13, 152627 HB ile D:\iei_user.gho oob2res.dll

Figure A-31: Restore Backup

Step 3: The screen is shown as in Figure A-32 when backup recovery is completed.

Press any key to reboot the system.



Figure A-32: Restore System Backup Complete Window

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A.4.4 Manual

To restore the last system backup, please follow the steps below.

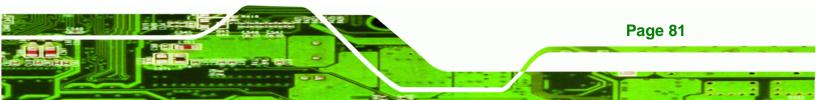
- **Step 1:** Type <**4**> and press **<Enter**> in the main menu.
- **Step 2:** The Symantec Ghost window appears. Use the Ghost program to backup or recover the system manually.

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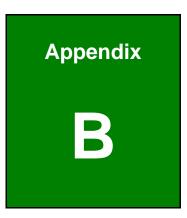
Sym	anteo Grost 1	L.S. Copyright (C) 1998-2008 Syma	ntee Corporation. A	ll rights reserved.	
F	Local					
	Peer to peer	F				
	<u>ShostCast</u>					
	gnosicasi					
12	<u>Options</u>					
âymenteo	jieip					
ĝ	Jut					
			1	Comanter	-	
			<u> </u>	S symanted		

Figure A-33: Symantec Ghost Window

Step 3: When backup or recovery is completed, press any key to reboot the system.







Safety Precautions



B.1 Safety Precautions

🖄 WARNING:

The precautions outlined in this appendix should be strictly followed. Failure to follow these precautions may result in permanent damage to the TANK-101B/BW.

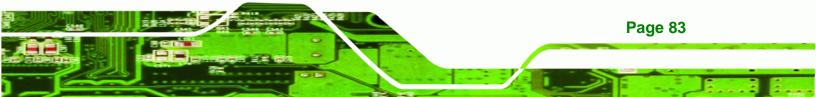
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Please follow the safety precautions outlined in the sections that follow:

B.1.1 General Safety Precautions

Please ensure the following safety precautions are adhered to at all times.

- Make sure the power is turned off and the power cord is disconnected when moving, installing or modifying the system.
- Do not apply voltage levels that exceed the specified voltage range.
 Doing so may cause fire and/or an electrical shock.
- Electric shocks can occur if opened while still powered on.
- Do not drop or insert any objects into the ventilation openings.
- If considerable amounts of dust, water, or fluids enter the system, turn off the power supply immediately, unplug the power cord, and contact the system vendor.
- DO NOT:
 - O Drop the system against a hard surface.
 - O Strike or exert excessive force onto the LCD panel.
 - O Touch any of the LCD panels with a sharp object
 - O In a site where the ambient temperature exceeds the rated temperature





B.1.2 Anti-static Precautions

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Failure to take ESD precautions during the installation of the TANK-101B/BW may result in permanent damage to the TANK-101B/BW and severe injury to the user.

Electrostatic discharge (ESD) can cause serious damage to electronic components, including the TANK-101B/BW. Dry climates are especially susceptible to ESD. It is therefore critical that whenever the TANK-101B/BW is opened and any of the electrical components are handled, the following anti-static precautions are strictly adhered to.

- Wear an anti-static wristband: Wearing a simple anti-static wristband can help to prevent ESD from damaging any electrical component.
- Self-grounding: Before handling any electrical component, touch any grounded conducting material. During the time the electrical component is handled, frequently touch any conducting materials that are connected to the ground.
- Use an anti-static pad: When configuring or working with an electrical component, place it on an antic-static pad. This reduces the possibility of ESD damage.
- Only handle the edges of the electrical component: When handling the electrical component, hold the electrical component by its edges.



B.1.3 Product Disposal

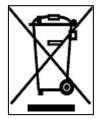


Risk of explosion if battery is replaced by and incorrect type. Only certified engineers should replace the on-board battery.

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Dispose of used batteries according to instructions and local regulations.

- Outside the European Union If you wish to dispose of used electrical and electronic products outside the European Union, please contact your local authority so as to comply with the correct disposal method.
- Within the European Union:



EU-wide legislation, as implemented in each Member State, requires that waste electrical and electronic products carrying the mark (left) must be disposed of separately from normal household waste. This includes monitors and electrical accessories, such as signal cables or power cords. When you need to dispose of your display products, please follow the

guidance of your local authority, or ask the shop where you purchased the product. The mark on electrical and electronic products only applies to the current European Union Member States.

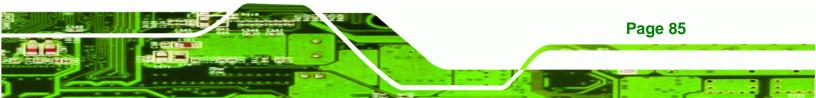
Please follow the national guidelines for electrical and electronic product disposal.

B.2 Maintenance and Cleaning Precautions

When maintaining or cleaning the TANK-101B/BW, please follow the guidelines below.

B.2.1 Maintenance and Cleaning

Prior to cleaning any part or component of the TANK-101B/BW, please read the details below.





- The interior of the TANK-101B/BW does not require cleaning. Keep fluids away from the TANK-101B/BW interior.
- Be cautious of all small removable components when vacuuming the TANK-101B/BW.
- Turn the TANK-101B/BW off before cleaning the TANK-101B/BW.
- Never drop any objects or liquids through the openings of the TANK-101B/BW.
- Be cautious of any possible allergic reactions to solvents or chemicals used when cleaning the TANK-101B/BW.
- Avoid eating, drinking and smoking within vicinity of the TANK-101B/BW.

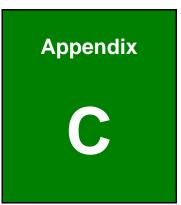
B.2.2 Cleaning Tools

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Some components in the TANK-101B/BW may only be cleaned using a product specifically designed for the purpose. In such case, the product will be explicitly mentioned in the cleaning tips. Below is a list of items to use when cleaning the TANK-101B/BW.

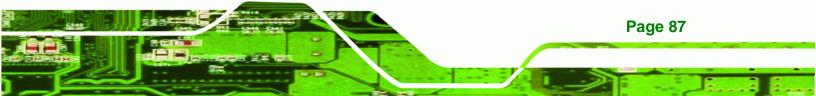
- *Cloth* Although paper towels or tissues can be used, a soft, clean piece of cloth is recommended when cleaning the TANK-101B/BW.
- Water or rubbing alcohol A cloth moistened with water or rubbing alcohol can be used to clean the TANK-101B/BW.
- Using solvents The use of solvents is not recommended when cleaning the TANK-101B/BW as they may damage the plastic parts.
- Vacuum cleaner Using a vacuum specifically designed for computers is one of the best methods of cleaning the TANK-101B/BW. Dust and dirt can restrict the airflow in the TANK-101B/BW and cause its circuitry to corrode.
- Cotton swabs Cotton swaps moistened with rubbing alcohol or water are excellent tools for wiping hard to reach areas.
- **Foam swabs** Whenever possible, it is best to use lint free swabs such as foam swabs for cleaning.

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Hazardous Materials Disclosure



C.1 Hazardous Materials Disclosure Table for IPB Products Certified as RoHS Compliant Under 2002/95/EC Without Mercury

The details provided in this appendix are to ensure that the product is compliant with the Peoples Republic of China (China) RoHS standards. The table below acknowledges the presences of small quantities of certain materials in the product, and is applicable to China RoHS only.

A label will be placed on each product to indicate the estimated "Environmentally Friendly Use Period" (EFUP). This is an estimate of the number of years that these substances would "not leak out or undergo abrupt change." This product may contain replaceable sub-assemblies/components which have a shorter EFUP such as batteries and lamps. These components will be separately marked.

Please refer to the table on the next page.

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Part Name	Toxic or Hazardous Substances and Elements						
	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent Chromium (CR(VI))	Polybrominated Biphenyls (PBB)	Polybrominated Diphenyl Ethers (PBDE)	
Housing	х	0	0	0	0	Х	
Display	х	0	0	0	0	Х	
Printed Circuit Board	х	0	0	0	0	Х	
Metal Fasteners	х	0	0	0	0	0	
Cable Assembly	х	0	0	0	0	Х	
Fan Assembly	х	0	0	0	0	Х	
Power Supply Assemblies	х	0	0	0	0	Х	
Battery	0	0	0	0	0	0	
 O: This toxic or hazardous substance is contained in all of the homogeneous materials for the part is below the limit requirement in SJ/T11363-2006 X: This toxic or hazardous substance is contained in at least one of the homogeneous materials for 							

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this part is above the limit requirement in SJ/T11363-2006





此附件旨在确保本产品符合中国 RoHS 标准。以下表格标示此产品中某有毒物质的含量符 合中国 RoHS 标准规定的限量要求。

本产品上会附有"环境友好使用期限"的标签,此期限是估算这些物质"不会有泄漏或突变"的 年限。本产品可能包含有较短的环境友好使用期限的可替换元件,像是电池或灯管,这些元 件将会单独标示出来。

部件名称	有毒有害物质或元素						
	铅	汞	镉	六价铬	多溴联苯	多溴二苯	
	(Pb)	(Hg)	(Cd)	(CR(VI))	(PBB)	醚	
						(PBDE)	
壳体	х	0	0	0	0	х	
显示	х	0	0	0	0	Х	
印刷电路板	х	0	0	0	0	х	
金属螺帽	х	0	0	0	0	0	
电缆组装	х	0	0	0	0	х	
风扇组装	х	0	0	0	0	х	
电力供应组装	х	0	0	0	0	х	
电池	0	0	0	0	0	0	
O:表示该有毒有害物质在该部件所有物质材料中的含量均在 SJ/T11363-2006 标准规定的限量要求以下。							
X:表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 SJ/T11363-2006 标准规定的限量要求。							

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